

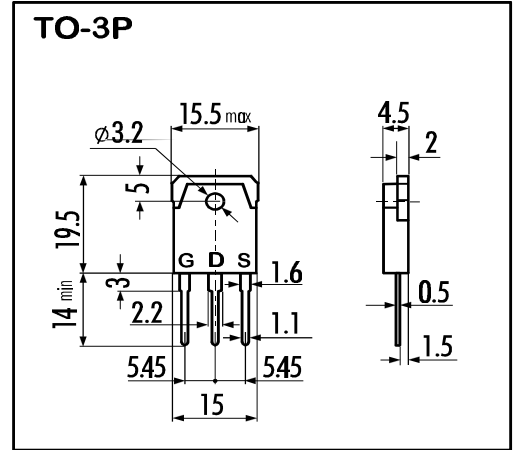
**> Features**

- High Speed Switching
- Low On-Resistance
- No Secondary Breakdown
- Low Driving Power
- High Voltage
- VGS = ± 30V Guarantee
- Repetitive Avalanche Rated

**> Applications**

- Switching Regulators
- UPS
- DC-DC converters
- General Purpose Power Amplifier

**> Outline Drawing**

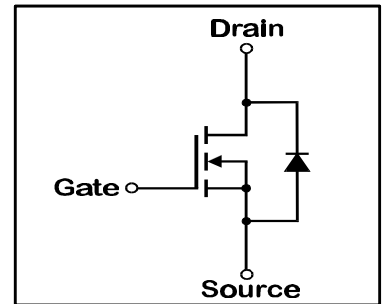


**> Maximum Ratings and Characteristics**

- Absolute Maximum Ratings (TC=25°C), unless otherwise specified

Item	Symbol	Rating	Unit
Drain-Source-Voltage	V <sub>DS</sub>	450	V
Drain-Gate-Voltage (R <sub>GS</sub> =20KΩ)	V <sub>DGR</sub>	450	V
Continuous Drain Current	I <sub>D</sub>	9	A
Pulsed Drain Current	I <sub>D(puls)</sub>	36	A
Gate-Source-Voltage	V <sub>GS</sub>	±30	V
Max. Power Dissipation	P <sub>D</sub>	80	W
Operating and Storage Temperature Range	T <sub>ch</sub>	150	°C
	T <sub>stg</sub>	-55 ~ +150	°C

**> Equivalent Circuit**



- Electrical Characteristics (TC=25°C), unless otherwise specified

Item	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Drain-Source Breakdown-Voltage	V <sub>(BR)DSS</sub>	I <sub>D</sub> =1mA V <sub>GS</sub> =0V	450			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	I <sub>D</sub> =1mA V <sub>DS</sub> =V <sub>GS</sub>	2,5	3,0	3,5	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =450V T <sub>ch</sub> =25°C			500	μA
		V <sub>GS</sub> =0V T <sub>ch</sub> =125°C			1,0	mA
Gate Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±30V V <sub>DS</sub> =0V		10	100	nA
Drain Source On-State Resistance	R <sub>DS(on)</sub>	I <sub>D</sub> =4,5A V <sub>GS</sub> =10V		0,87	1,0	Ω
Forward Transconductance	g <sub>fs</sub>	I <sub>D</sub> =4,5A V <sub>DS</sub> =25V	3,0	6,6		S
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =25V		1150	1700	pF
Output Capacitance	C <sub>oss</sub>	V <sub>GS</sub> =0V		130	200	pF
Reverse Transfer Capacitance	C <sub>rss</sub>	f=1MHz		50	75	pF
Turn-On-Time t <sub>on</sub> (t <sub>on</sub> =t <sub>d(on)</sub> +t <sub>r</sub> )	t <sub>d(on)</sub>	V <sub>CC</sub> =300V		20	30	ns
	t <sub>r</sub>	I <sub>D</sub> =10A		50	75	ns
	t <sub>f</sub>	V <sub>GS</sub> =10V		60	90	ns
Turn-Off-Time t <sub>off</sub> (t <sub>off</sub> =t <sub>d(off)</sub> +t <sub>f</sub> )	t <sub>d(off)</sub>	R <sub>GS</sub> =10 Ω		35	55	ns
	t <sub>f</sub>					
Avalanche Capability	I <sub>AV</sub>	L = 100μH T <sub>ch</sub> =25°C	9,0			A
Diode Forward On-Voltage	V <sub>SD</sub>	I <sub>F</sub> =2xI <sub>DR</sub> V <sub>GS</sub> =0V T <sub>ch</sub> =25°C		1,1	1,65	V
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> =I <sub>DR</sub> V <sub>GS</sub> =0V		550		ns
Reverse Recovery Charge	Q <sub>rr</sub>	-dI <sub>F</sub> /dt=100A/μs T <sub>ch</sub> =25°C		3,9		μC

- Thermal Characteristics

Item	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Thermal Resistance	R <sub>th(ch-a)</sub>	channel to air			35	°C/W
	R <sub>th(ch-c)</sub>	channel to case			1,56	°C/W

N-channel MOS-FET			
450V	1Ω	9A	80W

# 2SK2525-01

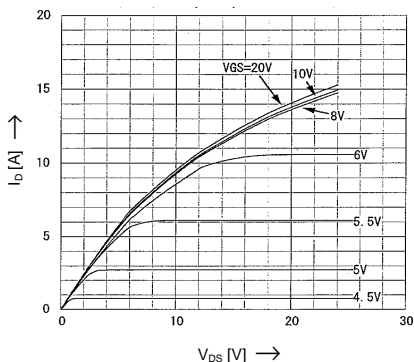
## FAP-II Series



### > Characteristics

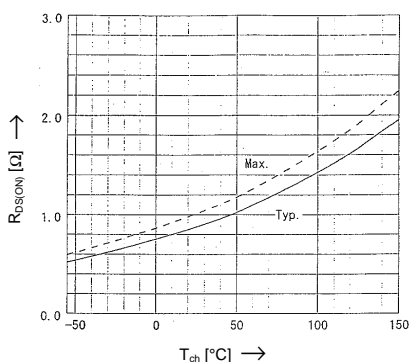
Typical Output Characteristics

$I_D = f(V_{DS})$ ; 80μs pulse test;  $T_C = 25^\circ\text{C}$



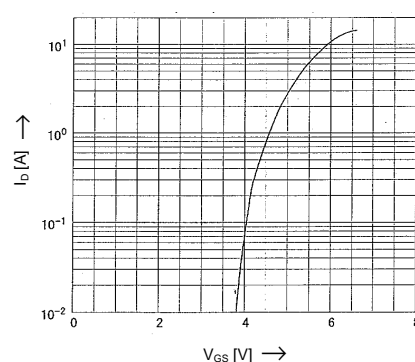
Drain-Source On-State Resistance

$R_{DS(on)} = f(T_{ch})$ ;  $I_D = 4.5\text{A}$ ;  $V_{GS} = 10\text{V}$



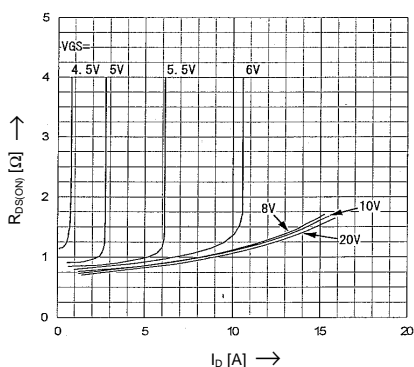
Typical Transfer Characteristics

$I_D = f(V_{GS})$ ; 80μs pulse test;  $V_{DS} = 25\text{V}$ ;  $T_{ch} = 25^\circ\text{C}$



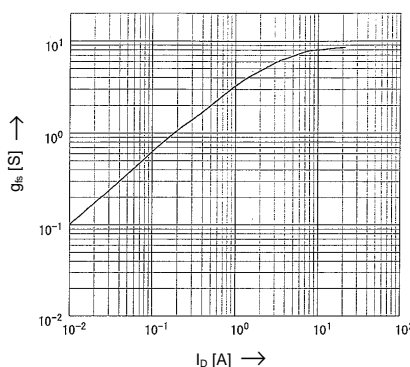
Typical Drain-Source On-State-Resistance

$R_{DS(on)} = f(I_D)$ ; 80μs pulse test;  $T_C = 25^\circ\text{C}$



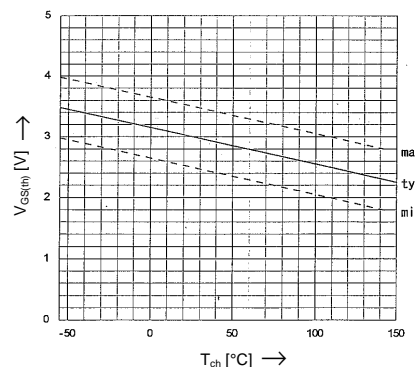
Typical Forward Transconductance

$g_{fs} = f(I_D)$ ; 80μs pulse test;  $V_{DS} = 25\text{V}$ ;  $T_{ch} = 25^\circ\text{C}$



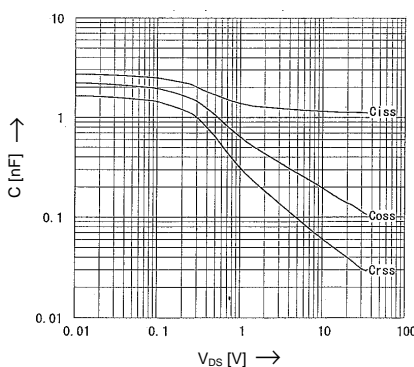
Gate Threshold Voltage

$V_{GS(th)} = f(T_{ch})$ ;  $I_D = 1\text{mA}$ ;  $V_{DS} = V_{GS}$



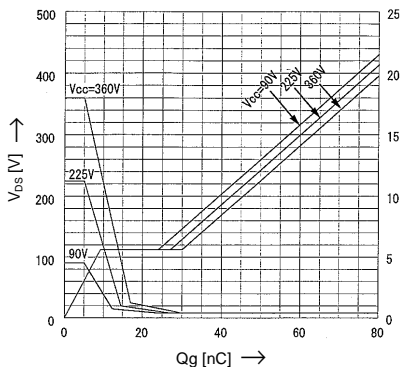
Typical Capacitances

$C = f(V_{DS})$ ;  $V_{GS} = 0\text{V}$ ;  $f = 1\text{MHz}$



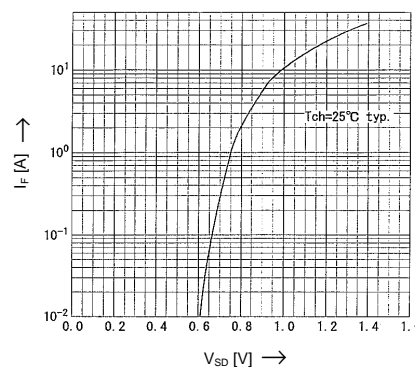
Typical Gate Charge Characteristics

$V_{GS} = f(Q_g)$ ;  $I_D = 9\text{A}$ ;  $T_C = 25^\circ\text{C}$



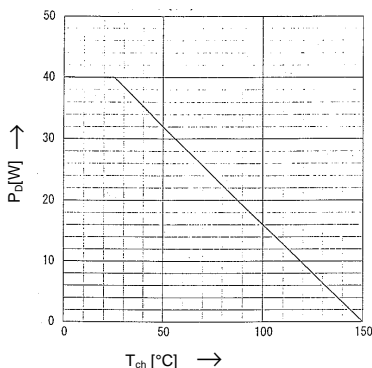
Forward Characteristics of Reverse Diode

$I_F = f(V_{SD})$ ; 80μs pulse test;  $V_{GS} = 0\text{V}$



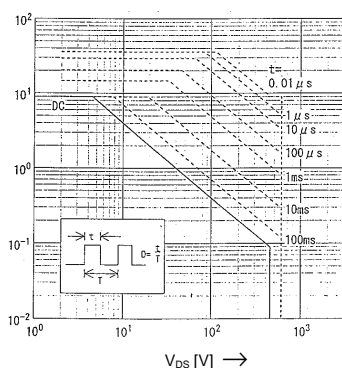
Power Dissipation

$P_D = f(T_C)$



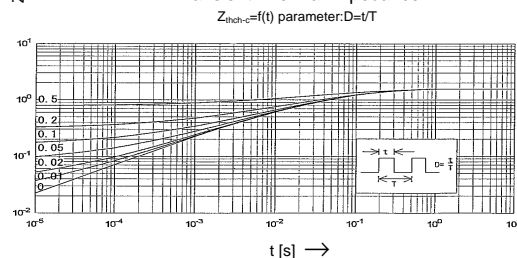
Safe Operation Area

$I_D = f(V_{DS})$ ;  $D = 0.01$ ;  $T_C = 25^\circ\text{C}$



Transient thermal impedance

$Z_{th(ch-c)} = f(t)$  parameter:  $D = t/T$



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